

Kindly add the following new claim 50:

Rule 1.126 46
B 2 50. (New) A circuit-connecting material interposed between facing circuit electrodes electrically connecting the electrodes in the pressing direction after curing by heat and pressure either by direct contact or via conductive particles present in the material, wherein:

the circuit-connecting material comprises the following components (1) to (3):

- (1) a curing agent capable of generating free radicals upon heating;
- (2) a hydroxyl-group-containing resin having a molecular weight of more than 10,000; and
- (3) a radical-polymerizable substance.